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**Understanding Embedded - CPLDs (Complex Programmable Logic Devices)** 

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

## **Applications of Embedded - CPLDs**

Details	
Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	16
Number of Macrocells	256
Number of Gates	5000
Number of I/O	164
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	256-BGA
Supplier Device Package	256-FBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epm7256aefi256-7

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

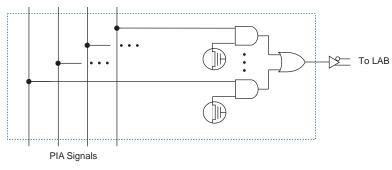
- Software design support and automatic place-and-route provided by Altera's development systems for Windows-based PCs and Sun SPARCstation, and HP 9000 Series 700/800 workstations
- Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, and VeriBest
- Programming support with Altera's Master Programming Unit (MPU), MasterBlaster™ serial/universal serial bus (USB) communications cable, ByteBlasterMV™ parallel port download cable, and BitBlaster™ serial download cable, as well as programming hardware from third-party manufacturers and any Jam™ STAPL File (.jam), Jam Byte-Code File (.jbc), or Serial Vector Format File- (.svf) capable in-circuit tester

## General Description

MAX 7000A (including MAX 7000AE) devices are high-density, high-performance devices based on Altera's second-generation MAX architecture. Fabricated with advanced CMOS technology, the EEPROM-based MAX 7000A devices operate with a 3.3-V supply voltage and provide 600 to 10,000 usable gates, ISP, pin-to-pin delays as fast as 4.5 ns, and counter speeds of up to 227.3 MHz. MAX 7000A devices in the -4, -5, -6, -7, and some -10 speed grades are compatible with the timing requirements for 33 MHz operation of the PCI Special Interest Group (PCI SIG) *PCI Local Bus Specification, Revision 2.2.* See Table 2.

Device			Speed	Grade		
	-4	-5	-6	-7	-10	-12
EPM7032AE	<b>✓</b>			<b>✓</b>	<b>✓</b>	
EPM7064AE	<b>✓</b>			<b>✓</b>	<b>✓</b>	
EPM7128A			<b>✓</b>	✓	✓	<b>✓</b>
EPM7128AE		<b>✓</b>		✓	✓	
EPM7256A			<b>✓</b>	<b>✓</b>	<b>✓</b>	<b>✓</b>
EPM7256AE		<b>✓</b>		<b>✓</b>	✓	
EPM7512AE				<b>✓</b>	<b>✓</b>	<b>✓</b>

Figure 5. MAX 7000A PIA Routing



While the routing delays of channel-based routing schemes in masked or FPGAs are cumulative, variable, and path-dependent, the MAX 7000A PIA has a predictable delay. The PIA makes a design's timing performance easy to predict.

## I/O Control Blocks

The I/O control block allows each I/O pin to be individually configured for input, output, or bidirectional operation. All I/O pins have a tri-state buffer that is individually controlled by one of the global output enable signals or directly connected to ground or  $V_{CC}.$  Figure 6 shows the I/O control block for MAX 7000A devices. The I/O control block has 6 or 10 global output enable signals that are driven by the true or complement of two output enable signals, a subset of the I/O pins, or a subset of the I/O macrocells.

PIA

6 or 10 Global
Output Enable Signals (1)

From
Macrocell

Past Input to
Macrocell

Register

To PIA

Figure 6. I/O Control Block of MAX 7000A Devices

## Note:

(1) EPM7032AE, EPM7064AE, EPM7128A, EPM7128AE, EPM7256A, and EPM7256AE devices have six output enable signals. EPM7512AE devices have 10 output enable signals.

When the tri-state buffer control is connected to ground, the output is tri-stated (high impedance) and the I/O pin can be used as a dedicated input. When the tri-state buffer control is connected to  $V_{CC}$ , the output is enabled.

The MAX 7000A architecture provides dual I/O feedback, in which macrocell and pin feedbacks are independent. When an I/O pin is configured as an input, the associated macrocell can be used for buried logic.

## **Programming Times**

The time required to implement each of the six programming stages can be broken into the following two elements:

- A pulse time to erase, program, or read the EEPROM cells.
- A shifting time based on the test clock (TCK) frequency and the number of TCK cycles to shift instructions, address, and data into the device.

By combining the pulse and shift times for each of the programming stages, the program or verify time can be derived as a function of the TCK frequency, the number of devices, and specific target device(s). Because different ISP-capable devices have a different number of EEPROM cells, both the total fixed and total variable times are unique for a single device.

## Programming a Single MAX 7000A Device

The time required to program a single MAX 7000A device in-system can be calculated from the following formula:

$$t_{PROG} = t_{PPULSE} + \frac{Cycle_{PTCK}}{f_{TCK}}$$

where:  $t_{PROG}$  = Programming time  $t_{PPULSE}$  = Sum of the fixed times to erase, program, and

verify the EEPROM cells

 $Cycle_{PTCK}$  = Number of TCK cycles to program a device

= TCK frequency

The ISP times for a stand-alone verification of a single MAX 7000A device can be calculated from the following formula:

$$t_{VER} = t_{VPULSE} + \frac{Cycle_{VTCK}}{f_{TCK}}$$

where:  $t_{VER}$  = Verify time

 $t_{VPULSE}$  = Sum of the fixed times to verify the EEPROM cells

 $Cycle_{VTCK}$  = Number of TCK cycles to verify a device

Table 7. MAX 70	000A Stand	OOA Stand-Alone Verification Times for Different Test Clock Frequencies										
Device		f <sub>TCK</sub>										
	10 MHz	5 MHz	2 MHz	1 MHz	500 kHz	200 kHz	100 kHz	50 kHz				
EPM7032AE	0.00	0.01	0.01	0.02	0.04	0.09	0.18	0.36	s			
EPM7064AE	0.01	0.01	0.02	0.04	0.07	0.18	0.35	0.70	S			
EPM7128AE	0.01	0.02	0.04	0.07	0.14	0.34	0.68	1.36	S			
EPM7256AE	0.02	0.03	0.08	0.15	0.30	0.75	1.49	2.98	S			
EPM7512AE	0.03	0.06	0.15	0.30	0.60	1.49	2.97	5.94	S			
EPM7128A (1)	0.08	0.14	0.29	0.56	1.09	2.67	5.31	10.59	S			
EPM7256A (1)	0.13	0.24	0.54	1.06	2.08	5.15	10.27	20.51	S			

#### Note to tables:

(1) EPM7128A and EPM7256A devices can only be programmed with an adaptive algorithm; users programming these two devices on platforms that cannot use an adaptive algorithm should use EPM7128AE and EPM7256AE devices.

# Programming with External Hardware

MAX 7000A devices can be programmed on Windows-based PCs with an Altera Logic Programmer card, the MPU, and the appropriate device adapter. The MPU performs continuity checks to ensure adequate electrical contact between the adapter and the device.



For more information, see the *Altera Programming Hardware Data Sheet*.

The Altera software can use text- or waveform-format test vectors created with the Altera Text Editor or Waveform Editor to test the programmed device. For added design verification, designers can perform functional testing to compare the functional device behavior with the results of simulation.

Data I/O, BP Microsystems, and other programming hardware manufacturers provide programming support for Altera devices.



For more information, see *Programming Hardware Manufacturers*.

## IEEE Std. 1149.1 (JTAG) Boundary-Scan Support

MAX 7000A devices include the JTAG BST circuitry defined by IEEE Std. 1149.1. Table 8 describes the JTAG instructions supported by MAX 7000A devices. The pin-out tables, available from the Altera web site (http://www.altera.com), show the location of the JTAG control pins for each device. If the JTAG interface is not required, the JTAG pins are available as user I/O pins.

Table 8. MAX 7000A	JTAG Instructions
JTAG Instruction	Description
SAMPLE/PRELOAD	Allows a snapshot of signals at the device pins to be captured and examined during normal device operation, and permits an initial data pattern output at the device pins
EXTEST	Allows the external circuitry and board-level interconnections to be tested by forcing a test pattern at the output pins and capturing test results at the input pins
BYPASS	Places the 1-bit bypass register between the TDI and TDO pins, which allows the BST data to pass synchronously through a selected device to adjacent devices during normal device operation
IDCODE	Selects the IDCODE register and places it between the TDI and TDO pins, allowing the IDCODE to be serially shifted out of TDO
USERCODE	Selects the 32-bit USERCODE register and places it between the TDI and TDO pins, allowing the USERCODE value to be shifted out of TDO. The USERCODE instruction is available for MAX 7000AE devices only
UESCODE	These instructions select the user electronic signature (UESCODE) and allow the UESCODE to be shifted out of TDO. UESCODE instructions are available for EPM7128A and EPM7256A devices only.
ISP Instructions	These instructions are used when programming MAX 7000A devices via the JTAG ports with the MasterBlaster, ByteBlasterMV, or BitBlaster download cable, or using a Jam STAPL File, JBC File, or SVF File via an embedded processor or test equipment.

The instruction register length of MAX 7000A devices is 10 bits. The user electronic signature (UES) register length in MAX 7000A devices is 16 bits. The MAX 7000AE USERCODE register length is 32 bits. Tables 9 and 10 show the boundary-scan register length and device IDCODE information for MAX 7000A devices.

Table 9. MAX 7000A Boundary-Scan Register Length						
Device	Boundary-Scan Register Length					
EPM7032AE	96					
EPM7064AE	192					
EPM7128A	288					
EPM7128AE	288					
EPM7256A	480					
EPM7256AE	480					
EPM7512AE	624					

Table 10. 32	Table 10. 32-Bit MAX 7000A Device IDCODENote (1)									
Device		IDCODE (32 Bits)								
	Version (4 Bits)	Part Number (16 Bits)	Manufacturer's Identity (11 Bits)	1 (1 Bit) (2)						
EPM7032AE	0001	0111 0000 0011 0010	00001101110	1						
EPM7064AE	0001	0111 0000 0110 0100	00001101110	1						
EPM7128A	0000	0111 0001 0010 1000	00001101110	1						
EPM7128AE	0001	0111 0001 0010 1000	00001101110	1						
EPM7256A	0000	0111 0010 0101 0110	00001101110	1						
EPM7256AE	0001	0111 0010 0101 0110	00001101110	1						
EPM7512AE	0001	0111 0101 0001 0010	00001101110	1						

#### Notes:

- (1) The most significant bit (MSB) is on the left.
- (2) The least significant bit (LSB) for all JTAG IDCODEs is 1.



See Application Note 39 (IEEE 1149.1 (JTAG) Boundary-Scan Testing in Altera Devices) for more information on JTAG BST.

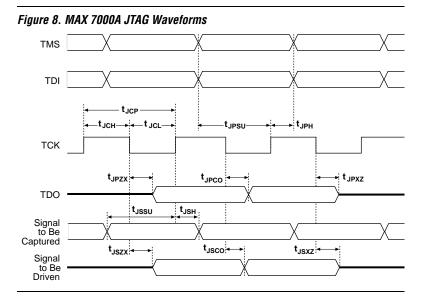


Figure 8 shows timing information for the JTAG signals.

Table 11 shows the JTAG timing parameters and values for MAX 7000A devices.

Table 1	Table 11. JTAG Timing Parameters & Values for MAX 7000A Devices Note (1)							
Symbol	Parameter	Min	Max	Unit				
t <sub>JCP</sub>	TCK clock period	100		ns				
t <sub>JCH</sub>	TCK clock high time	50		ns				
t <sub>JCL</sub>	TCK clock low time	50		ns				
t <sub>JPSU</sub>	JTAG port setup time	20		ns				
t <sub>JPH</sub>	JTAG port hold time	45		ns				
t <sub>JPCO</sub>	JTAG port clock to output		25	ns				
t <sub>JPZX</sub>	JTAG port high impedance to valid output		25	ns				
t <sub>JPXZ</sub>	JTAG port valid output to high impedance		25	ns				
t <sub>JSSU</sub>	Capture register setup time	20		ns				
t <sub>JSH</sub>	Capture register hold time	45		ns				
t <sub>JSCO</sub>	Update register clock to output		25	ns				
t <sub>JSZX</sub>	Update register high impedance to valid output		25	ns				
t <sub>JSXZ</sub>	Update register valid output to high impedance		25	ns				

Note:

<sup>(1)</sup> Timing parameters shown in this table apply for all specified VCCIO levels.

## Programmable Speed/Power Control

MAX 7000A devices offer a power-saving mode that supports low-power operation across user-defined signal paths or the entire device. This feature allows total power dissipation to be reduced by 50% or more because most logic applications require only a small fraction of all gates to operate at maximum frequency.

The designer can program each individual macrocell in a MAX 7000A device for either high-speed (i.e., with the Turbo Bit<sup>TM</sup> option turned on) or low-power operation (i.e., with the Turbo Bit option turned off). As a result, speed-critical paths in the design can run at high speed, while the remaining paths can operate at reduced power. Macrocells that run at low power incur a nominal timing delay adder ( $t_{LPA}$ ) for the  $t_{LAD}$ ,  $t_{LAC}$ ,  $t_{IC}$ ,  $t_{EN}$ ,  $t_{SEXP}$ ,  $t_{ACL}$ , and  $t_{CPPW}$  parameters.

## Output Configuration

MAX 7000A device outputs can be programmed to meet a variety of system-level requirements.

## MultiVolt I/O Interface

The MAX 7000A device architecture supports the MultiVolt I/O interface feature, which allows MAX 7000A devices to connect to systems with differing supply voltages. MAX 7000A devices in all packages can be set for 2.5-V, 3.3-V, or 5.0-V I/O pin operation. These devices have one set of VCC pins for internal operation and input buffers (VCCINT), and another set for I/O output drivers (VCCIO).

The VCCIO pins can be connected to either a 3.3-V or 2.5-V power supply, depending on the output requirements. When the VCCIO pins are connected to a 2.5-V power supply, the output levels are compatible with 2.5-V systems. When the VCCIO pins are connected to a 3.3-V power supply, the output high is at 3.3 V and is therefore compatible with 3.3-V or 5.0-V systems. Devices operating with V<sub>CCIO</sub> levels lower than 3.0 V incur a slightly greater timing delay of  $t_{OD2}$  instead of  $t_{OD1}$ . Inputs can always be driven by 2.5-V, 3.3-V, or 5.0-V signals.

Table 12 describes the MAX 7000A MultiVolt I/O support.

Table 12. MAX 7000A MultiVolt I/O Support									
V <sub>CC10</sub> Voltage Input Signal (V) Output Signal (V)									
	2.5	3.3	5.0	2.5	3.3	5.0			
2.5	<b>✓</b>	<b>✓</b>	<b>✓</b>	<b>✓</b>					
3.3	<b>✓</b>	<b>✓</b>	<b>✓</b>		<b>✓</b>	<b>✓</b>			

### MAX 7000A Programmable Logic Device Data Sheet

#### Notes to tables:

- (1) See the Operating Requirements for Altera Devices Data Sheet.
- (2) Minimum DC input voltage is –0.5 V. During transitions, the inputs may undershoot to –2.0 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) For EPM7128A and EPM7256A devices only, V<sub>CC</sub> must rise monotonically.
- (4) In MAX 7000AE devices, all pins, including dedicated inputs, I/O pins, and JTAG pins, may be driven before V<sub>CCINT</sub> and V<sub>CCIO</sub> are powered.
- (5) These devices support in-system programming for -40° to 100° C. For in-system programming support between -40° and 0° C, contact Altera Applications.
- (6) These values are specified under the recommended operating conditions shown in Table 14 on page 28.
- (7) The parameter is measured with 50% of the outputs each sourcing the specified current. The  $I_{OH}$  parameter refers to high-level TTL or CMOS output current.
- (8) The parameter is measured with 50% of the outputs each sinking the specified current. The I<sub>OL</sub> parameter refers to low-level TTL or CMOS output current.
- (9) This value is specified for normal device operation. For MAX 7000AE devices, the maximum leakage current during power-up is ±300 μA. For EPM7128A and EPM7256A devices, leakage current during power-up is not specified.
- (10) For EPM7128A and EPM7256A devices, this pull-up exists while a device is programmed in-system.
- (11) For MAX 7000AE devices, this pull-up exists while devices are programmed in-system and in unprogrammed devices during power-up.
- (12) Capacitance is measured at 25 °C and is sample-tested only. The OE1 pin (high-voltage pin during programming) has a maximum capacitance of 20 pF.
- (13) The POR time for MAX 7000AE devices (except MAX 7128A and MAX 7256A devices) does not exceed 100  $\mu$ s. The sufficient V<sub>CCINT</sub> voltage level for POR is 3.0 V. The device is fully initialized within the POR time after V<sub>CCINT</sub> reaches the sufficient POR voltage level.

Symbol	Parameter	Conditions			Speed	Grade			Unit
			-	4	-	7		10	
			Min	Max	Min	Max	Min	Max	
t <sub>IC</sub>	Array clock delay			1.2		2.0		2.5	ns
t <sub>EN</sub>	Register enable time			0.6		1.0		1.2	ns
$t_{GLOB}$	Global control delay			0.8		1.3		1.9	ns
t <sub>PRE</sub>	Register preset time			1.2		1.9		2.6	ns
t <sub>CLR</sub>	Register clear time			1.2		1.9		2.6	ns
$t_{PIA}$	PIA delay	(2)		0.9		1.5		2.1	ns
$t_{LPA}$	Low-power adder	(6)		2.5		4.0		5.0	ns

Symbol	Parameter	Conditions	Speed Grade						
			-4	4	-	7	-1	0	
			Min	Max	Min	Max	Min	Max	1
t <sub>PD1</sub>	Input to non- registered output	C1 = 35 pF (2)		4.5		7.5		10.0	ns
t <sub>PD2</sub>	I/O input to non- registered output	C1 = 35 pF (2)		4.5		7.5		10.0	ns
t <sub>SU</sub>	Global clock setup time	(2)	2.8		4.7		6.2		ns
t <sub>H</sub>	Global clock hold time	(2)	0.0		0.0		0.0		ns
t <sub>FSU</sub>	Global clock setup time of fast input		2.5		3.0		3.0		ns
t <sub>FH</sub>	Global clock hold time of fast input		0.0		0.0		0.0		ns
t <sub>CO1</sub>	Global clock to output delay	C1 = 35 pF	1.0	3.1	1.0	5.1	1.0	7.0	ns
t <sub>CH</sub>	Global clock high time		2.0		3.0		4.0		ns
t <sub>CL</sub>	Global clock low time		2.0		3.0		4.0		ns
t <sub>ASU</sub>	Array clock setup time	(2)	1.6		2.6		3.6		ns
t <sub>AH</sub>	Array clock hold time	(2)	0.3		0.4		0.6		ns
t <sub>ACO1</sub>	Array clock to output delay	C1 = 35 pF (2)	1.0	4.3	1.0	7.2	1.0	9.6	ns
t <sub>ACH</sub>	Array clock high time		2.0		3.0		4.0		ns
t <sub>ACL</sub>	Array clock low time		2.0		3.0		4.0		ns
t <sub>CPPW</sub>	Minimum pulse width for clear and preset	(3)	2.0		3.0		4.0		ns
t <sub>CNT</sub>	Minimum global clock period	(2)		4.5		7.4		10.0	ns
f <sub>CNT</sub>	Maximum internal global clock frequency	(2), (4)	222.2		135.1		100.0		MHz
t <sub>ACNT</sub>	Minimum array clock period	(2)		4.5		7.4		10.0	ns
f <sub>ACNT</sub>	Maximum internal array clock frequency	(2), (4)	222.2		135.1		100.0		MHz

Symbol	Parameter	Conditions			Speed	Grade			Unit
			-	4		-7	-10		
			Min	Max	Min	Max	Min	Max	
t <sub>IN</sub>	Input pad and buffer delay			0.6		1.1		1.4	ns
t <sub>IO</sub>	I/O input pad and buffer delay			0.6		1.1		1.4	ns
t <sub>FIN</sub>	Fast input delay			2.5		3.0		3.7	ns
t <sub>SEXP</sub>	Shared expander delay			1.8		3.0		3.9	ns
$t_{PEXP}$	Parallel expander delay			0.4		0.7		0.9	ns
$t_{LAD}$	Logic array delay			1.5		2.5		3.2	ns
t <sub>LAC</sub>	Logic control array delay			0.6		1.0		1.2	ns
t <sub>IOE</sub>	Internal output enable delay			0.0		0.0		0.0	ns
t <sub>OD1</sub>	Output buffer and pad delay, slow slew rate = off V <sub>CCIO</sub> = 3.3 V	C1 = 35 pF		0.8		1.3		1.8	ns
t <sub>OD2</sub>	Output buffer and pad delay, slow slew rate = off V <sub>CCIO</sub> = 2.5 V	C1 = 35 pF (5)		1.3		1.8		2.3	ns
t <sub>OD3</sub>	Output buffer and pad delay, slow slew rate = on V <sub>CCIO</sub> = 2.5 V or 3.3 V	C1 = 35 pF		5.8		6.3		6.8	ns
t <sub>ZX1</sub>	Output buffer enable delay, slow slew rate = off $V_{CCIO} = 3.3 \text{ V}$	C1 = 35 pF		4.0		4.0		5.0	ns
t <sub>ZX2</sub>	Output buffer enable delay, slow slew rate = off $V_{CCIO} = 2.5 \text{ V}$	C1 = 35 pF (5)		4.5		4.5		5.5	ns
t <sub>ZX3</sub>	Output buffer enable delay, slow slew rate = on V <sub>CCIO</sub> = 3.3 V	C1 = 35 pF		9.0		9.0		10.0	ns
$t_{XZ}$	Output buffer disable delay	C1 = 5 pF		4.0		4.0		5.0	ns
t <sub>SU</sub>	Register setup time		1.3		2.0		2.9		ns
t <sub>H</sub>	Register hold time		0.6		1.0		1.3		ns
t <sub>FSU</sub>	Register setup time of fast input		1.0		1.5		1.5		ns
t <sub>FH</sub>	Register hold time of fast input		1.5		1.5		1.5		ns
$t_{RD}$	Register delay			0.7		1.2		1.6	ns
t <sub>COMB</sub>	Combinatorial delay			0.6		0.9		1.3	ns
t <sub>IC</sub>	Array clock delay			1.2		1.9		2.5	ns

Symbol	Parameter	Conditions	Conditions Speed Grade						Unit
			-	5	-	7	-	10	1
			Min	Max	Min	Max	Min	Max	
t <sub>EN</sub>	Register enable time			0.7		1.0		1.3	ns
$t_{GLOB}$	Global control delay			1.1		1.6		2.0	ns
t <sub>PRE</sub>	Register preset time			1.4		2.0		2.7	ns
t <sub>CLR</sub>	Register clear time			1.4		2.0		2.7	ns
$t_{PIA}$	PIA delay	(2)		1.4		2.0		2.6	ns
$t_{LPA}$	Low-power adder	(6)		4.0		4.0		5.0	ns

Symbol	Parameter	Conditions			Speed	Grade			Unit
			-5		-7		-10		1
			Min	Max	Min	Max	Min	Max	
$t_{IC}$	Array clock delay			1.2		1.6		2.1	ns
t <sub>EN</sub>	Register enable time			0.8		1.0		1.3	ns
t <sub>GLOB</sub>	Global control delay			1.0		1.5		2.0	ns
t <sub>PRE</sub>	Register preset time			1.6		2.3		3.0	ns
t <sub>CLR</sub>	Register clear time			1.6		2.3		3.0	ns
$t_{PIA}$	PIA delay	(2)		1.7		2.4		3.2	ns
$t_{LPA}$	Low-power adder	(6)		4.0		4.0		5.0	ns

Table 25	5. EPM7512AE External	Timing Paran	neters	Note (1)							
Symbol	Parameter	Conditions	Speed Grade								
			-7	7	-	10	-1	12			
			Min	Max	Min	Max	Min	Max			
t <sub>PD1</sub>	Input to non- registered output	C1 = 35 pF (2)		7.5		10.0		12.0	ns		
t <sub>PD2</sub>	I/O input to non- registered output	C1 = 35 pF (2)		7.5		10.0		12.0	ns		
t <sub>SU</sub>	Global clock setup time	(2)	5.6		7.6		9.1		ns		
t <sub>H</sub>	Global clock hold time	(2)	0.0		0.0		0.0		ns		
t <sub>FSU</sub>	Global clock setup time of fast input		3.0		3.0		3.0		ns		
t <sub>FH</sub>	Global clock hold time of fast input		0.0		0.0		0.0		ns		
t <sub>CO1</sub>	Global clock to output delay	C1 = 35 pF	1.0	4.7	1.0	6.3	1.0	7.5	ns		
t <sub>CH</sub>	Global clock high time		3.0		4.0		5.0		ns		
t <sub>CL</sub>	Global clock low time		3.0		4.0		5.0		ns		
t <sub>ASU</sub>	Array clock setup time	(2)	2.5		3.5		4.1		ns		
t <sub>AH</sub>	Array clock hold time	(2)	0.2		0.3		0.4		ns		
t <sub>ACO1</sub>	Array clock to output delay	C1 = 35 pF (2)	1.0	7.8	1.0	10.4	1.0	12.5	ns		
t <sub>ACH</sub>	Array clock high time		3.0		4.0		5.0		ns		
t <sub>ACL</sub>	Array clock low time		3.0		4.0		5.0		ns		
t <sub>CPPW</sub>	Minimum pulse width for clear and preset	(3)	3.0		4.0		5.0		ns		
t <sub>CNT</sub>	Minimum global clock period	(2)		8.6		11.5		13.9	ns		
f <sub>CNT</sub>	Maximum internal global clock frequency	(2), (4)	116.3		87.0		71.9		MHz		
t <sub>ACNT</sub>	Minimum array clock period	(2)		8.6		11.5		13.9	ns		
f <sub>ACNT</sub>	Maximum internal array clock frequency	(2), (4)	116.3		87.0		71.9		MHz		

Symbol	Parameter	Conditions	Speed Grade							
			-7		-10		-12			
			Min	Max	Min	Max	Min	Max		
t <sub>IN</sub>	Input pad and buffer delay			0.7		0.9		1.0	ns	
t <sub>IO</sub>	I/O input pad and buffer delay			0.7		0.9		1.0	ns	
t <sub>FIN</sub>	Fast input delay			3.1		3.6		4.1	ns	
t <sub>SEXP</sub>	Shared expander delay			2.7		3.5		4.4	ns	
t <sub>PEXP</sub>	Parallel expander delay			0.4		0.5		0.6	ns	
$t_{LAD}$	Logic array delay			2.2		2.8		3.5	ns	
t <sub>LAC</sub>	Logic control array delay			1.0		1.3		1.7	ns	
t <sub>IOE</sub>	Internal output enable delay			0.0		0.0		0.0	ns	
t <sub>OD1</sub>	Output buffer and pad delay, slow slew rate = off V <sub>CCIO</sub> = 3.3 V	C1 = 35 pF		1.0		1.5		1.7	ns	
t <sub>OD2</sub>	Output buffer and pad delay, slow slew rate = off $V_{CCIO} = 2.5 \text{ V}$	C1 = 35 pF (5)		1.5		2.0		2.2	ns	
t <sub>OD3</sub>	Output buffer and pad delay, slow slew rate = on $V_{CCIO} = 2.5 \text{ V or } 3.3 \text{ V}$	C1 = 35 pF		6.0		6.5		6.7	ns	
t <sub>ZX1</sub>	Output buffer enable delay, slow slew rate = off $V_{CCIO} = 3.3 \text{ V}$	C1 = 35 pF		4.0		5.0		5.0	ns	
t <sub>ZX2</sub>	Output buffer enable delay, slow slew rate = off $V_{CCIO} = 2.5 \text{ V}$	C1 = 35 pF (5)		4.5		5.5		5.5	ns	
t <sub>ZX3</sub>	Output buffer enable delay, slow slew rate = on $V_{CCIO} = 3.3 \text{ V}$	C1 = 35 pF		9.0		10.0		10.0	ns	
$t_{XZ}$	Output buffer disable delay	C1 = 5 pF		4.0		5.0		5.0	ns	
t <sub>SU</sub>	Register setup time		2.1		3.0		3.5		ns	
t <sub>H</sub>	Register hold time		0.6		0.8		1.0		ns	
t <sub>FSU</sub>	Register setup time of fast input		1.6		1.6		1.6		ns	
t <sub>FH</sub>	Register hold time of fast input		1.4		1.4		1.4		ns	
$t_{RD}$	Register delay			1.3		1.7		2.1	ns	
t <sub>COMB</sub>	Combinatorial delay			0.6		0.8		1.0	ns	

Symbol	Parameter	Conditions				Speed	Grade				Unit
			-6		-7		-10		-12		
			Min	Max	Min	Max	Min	Max	Min	Max	-
t <sub>RD</sub>	Register delay			1.7		2.1		2.8		3.3	ns
t <sub>COMB</sub>	Combinatorial delay			1.7		2.1		2.8		3.3	ns
t <sub>IC</sub>	Array clock delay			2.4		3.0		4.1		4.9	ns
t <sub>EN</sub>	Register enable time			2.4		3.0		4.1		4.9	ns
t <sub>GLOB</sub>	Global control delay			1.0		1.2		1.7		2.0	ns
t <sub>PRE</sub>	Register preset time			3.1		3.9		5.2		6.2	ns
t <sub>CLR</sub>	Register clear time			3.1		3.9		5.2		6.2	ns
t <sub>PIA</sub>	PIA delay	(2)		0.9		1.1		1.5		1.8	ns
$t_{LPA}$	Low-power adder	(6)		11.0		10.0		10.0		10.0	ns

Table 2	Table 29. EPM7256A External Timing Parameters Note (1)  Symbol Parameter Conditions Speed Grade Unit													
Symbol	Parameter	Conditions	Speed Grade											
			-6		-7		-10		-12					
			Min	Max	Min	Max	Min	Max	Min	Max				
t <sub>PD1</sub>	Input to non-registered output	C1 = 35 pF (2)		6.0		7.5		10.0		12.0	ns			
t <sub>PD2</sub>	I/O input to non- registered output	C1 = 35 pF (2)		6.0		7.5		10.0		12.0	ns			
t <sub>SU</sub>	Global clock setup time	(2)	3.7		4.6		6.2		7.4		ns			
t <sub>H</sub>	Global clock hold time	(2)	0.0		0.0		0.0		0.0		ns			
t <sub>FSU</sub>	Global clock setup time of fast input		2.5		3.0		3.0		3.0		ns			
t <sub>FH</sub>	Global clock hold time of fast input		0.0		0.0		0.0		0.0		ns			
t <sub>CO1</sub>	Global clock to output delay	C1 = 35 pF	1.0	3.3	1.0	4.2	1.0	5.5	1.0	6.6	ns			
t <sub>CH</sub>	Global clock high time		3.0		3.0		4.0		4.0		ns			
t <sub>CL</sub>	Global clock low time		3.0		3.0		4.0		4.0		ns			
t <sub>ASU</sub>	Array clock setup time	(2)	8.0		1.0		1.4		1.6		ns			
t <sub>AH</sub>	Array clock hold time	(2)	1.9		2.7		4.0		5.1		ns			
t <sub>ACO1</sub>	Array clock to output delay	C1 = 35 pF (2)	1.0	6.2	1.0	7.8	1.0	10.3	1.0	12.4	ns			
t <sub>ACH</sub>	Array clock high time		3.0		3.0		4.0		4.0		ns			
t <sub>ACL</sub>	Array clock low time		3.0		3.0		4.0		4.0		ns			
t <sub>CPPW</sub>	Minimum pulse width for clear and preset	(3)	3.0		3.0		4.0		4.0		ns			
t <sub>CNT</sub>	Minimum global clock period	(2)		6.4		8.0		10.7		12.8	ns			
f <sub>CNT</sub>	Maximum internal global clock frequency	(2), (4)	156.3		125.0		93.5		78.1		MHz			
t <sub>ACNT</sub>	Minimum array clock period	(2)		6.4		8.0		10.7		12.8	ns			
f <sub>ACNT</sub>	Maximum internal array clock frequency	(2), (4)	156.3		125.0		93.5		78.1		MHz			

Symbol	Parameter	Conditions	Speed Grade								
			-6		-7		-10		-12		
			Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>IN</sub>	Input pad and buffer delay			0.3		0.4		0.5		0.6	ns
t <sub>IO</sub>	I/O input pad and buffer delay			0.3		0.4		0.5		0.6	ns
$t_{FIN}$	Fast input delay			2.4		3.0		3.4		3.8	ns
t <sub>SEXP</sub>	Shared expander delay			2.8		3.5		4.7		5.6	ns
t <sub>PEXP</sub>	Parallel expander delay			0.5		0.6		0.8		1.0	ns
$t_{LAD}$	Logic array delay			2.5		3.1		4.2		5.0	ns
t <sub>LAC</sub>	Logic control array delay			2.5		3.1		4.2		5.0	ns
t <sub>IOE</sub>	Internal output enable delay			0.2		0.3		0.4		0.5	ns
t <sub>OD1</sub>	Output buffer and pad delay, slow slew rate = off V <sub>CCIO</sub> = 3.3 V	C1 = 35 pF		0.3		0.4		0.5		0.6	ns
t <sub>OD2</sub>	Output buffer and pad delay, slow slew rate = off V <sub>CCIO</sub> = 2.5 V	C1 = 35 pF (5)		0.8		0.9		1.0		1.1	ns
t <sub>OD3</sub>	Output buffer and pad delay slow slew rate = on V <sub>CCIO</sub> = 2.5 V or 3.3 V	C1 = 35 pF		5.3		5.4		5.5		5.6	ns
t <sub>ZX1</sub>	Output buffer enable delay slow slew rate = off V <sub>CCIO</sub> = 3.3 V	C1 = 35 pF		4.0		4.0		5.0		5.0	ns
t <sub>ZX2</sub>	Output buffer enable delay slow slew rate = off V <sub>CCIO</sub> = 2.5 V	C1 = 35 pF (5)		4.5		4.5		5.5		5.5	ns
t <sub>ZX3</sub>	Output buffer enable delay slow slew rate = on V <sub>CCIO</sub> = 2.5 V or 3.3 V	C1 = 35 pF		9.0		9.0		10.0		10.0	ns
$t_{XZ}$	Output buffer disable delay	C1 = 5 pF		4.0		4.0		5.0		5.0	ns
t <sub>SU</sub>	Register setup time		1.0		1.3		1.7		2.0		ns
t <sub>H</sub>	Register hold time		1.7		2.4		3.7		4.7		ns
t <sub>FSU</sub>	Register setup time of fast input		1.2		1.4		1.4		1.4		ns
t <sub>FH</sub>	Register hold time of fast input		1.3		1.6		1.6		1.6		ns
$t_{RD}$	Register delay			1.6		2.0		2.7		3.2	ns